

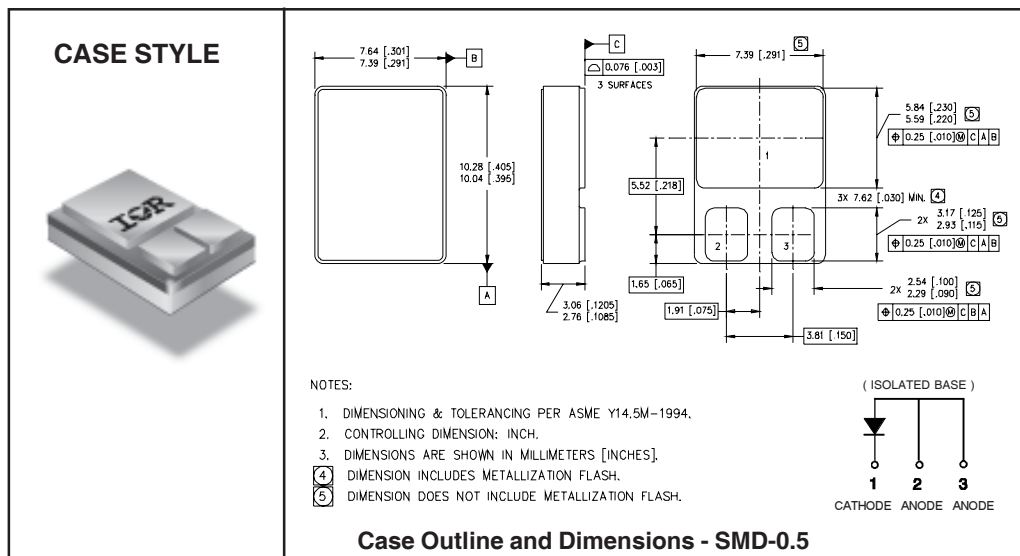
Major Ratings and Characteristics

Characteristics	1N7038U3	Units
$I_{F(AV)}$	30	A
V_{RRM}	150	V
I_{FSM} @ $t_p = 8.3ms$ half-sine	140	A
V_F @ 30Apk, $T_J = 125^\circ C$	0.92	V
T_J, T_{stg} Operating and storage	-65 to 150	$^\circ C$

Description/Features

The 1N7038U3 Schottky rectifier has been expressly designed to meet the rigorous requirements of high reliability environments. It is packaged in the hermetic surface mount SMD-0.5 ceramic package. The device's forward voltage drop and reverse leakage current are optimized for the lowest power loss and the highest circuit efficiency for typical high frequency switching power supplies and resonant power converters. Full MIL-PRF-19500 quality conformance testing is available on source control drawings to TX, TXV and S quality levels.

- Hermetically Sealed
- Low Forward Voltage Drop
- High Frequency Operation
- Guard Ring for Enhanced Ruggedness and Long term Reliability
- Surface Mount
- Lightweight



Voltage Ratings

Part number	1N7038U3
V _R Max. DC Reverse Voltage (V)	150
V _{RWM} Max. Working Peak Reverse Voltage (V)	

Absolute Maximum Ratings

Parameters	Limits	Units	Conditions
I _{F(AV)} Max. Average Forward Current See Fig. 5	30	A	50% duty cycle @ T _C = 83°C, square waveform
I _{FSM} Max. Peak One Cycle Non - Repetitive Surge Current	140	A	@ t _p = 8.3ms half-sine

Electrical Specifications

Parameters	Limits	Units	Conditions
V _{FM} Max. Forward Voltage Drop See Fig. 1①	1.07	V	@15A T _J = -55°C ②
	1.26	V	@30A
	0.96	V	@15A T _J = 25°C ②
	1.18	V	@30A
	0.75	V	@15A T _J = 125°C ②
	0.92	V	@30A
I _{RM} Max. Reverse Leakage Current See Fig. 2①	0.12	mA	T _J = 25°C V _R = rated V _R
	6.0	mA	T _J = 125°C
C _T Max. Junction Capacitance	340	pF	V _R = 5V _{DC} (1MHz, 25°C)
L _S Typical Series Inductance	4.8	nH	Measured from center of cathode pad to center of anode pad

Thermal-Mechanical Specifications

Parameters	Limits	Units	Conditions
T _J Max. Junction Temperature Range	-65 to 150	°C	
T _{stg} Max. Storage Temperature Range	-65 to 150	°C	
R _{thJC} Max. Thermal Resistance, Junction to Case	1.82	°C/W	DC operation See Fig. 4
wt Weight (Typical)	1.0	g	
Die Size (Typical)	125X125	mils	
Case Style	SMD-0.5		

① Pulse Width < 300μs, Duty Cycle < 2%

② Pins 2 and 3 externally tied together

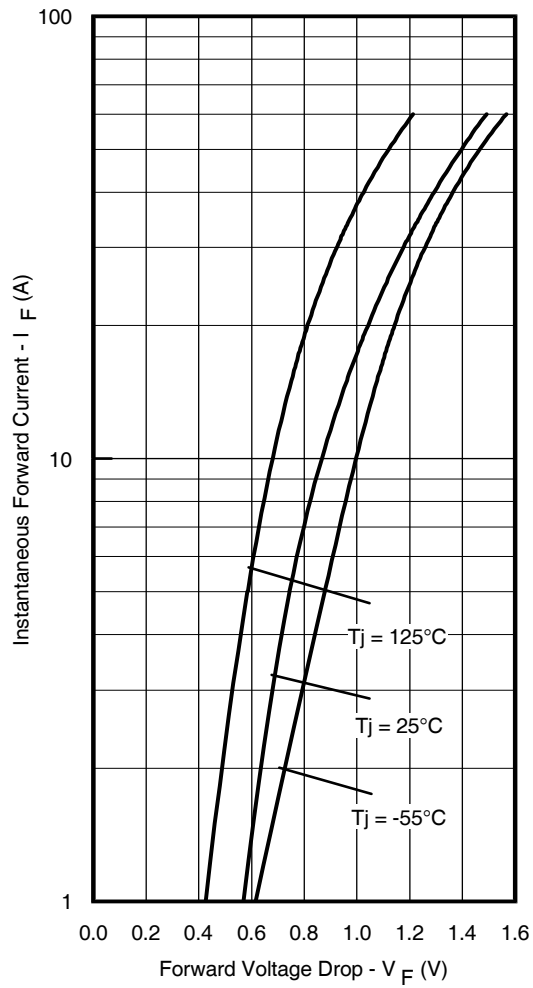


Fig. 1 - Max. Forward Voltage Drop Characteristics

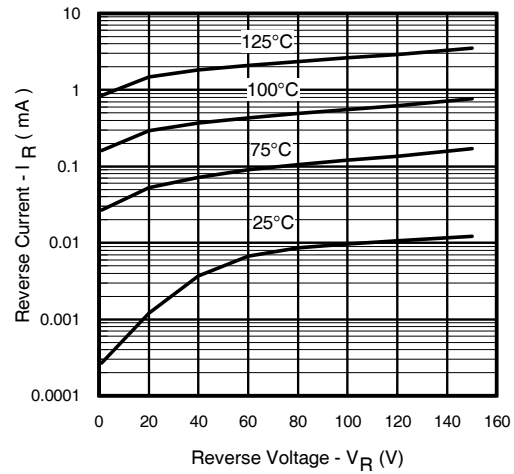


Fig. 2 - Typical Values of Reverse Current Vs. Reverse Voltage

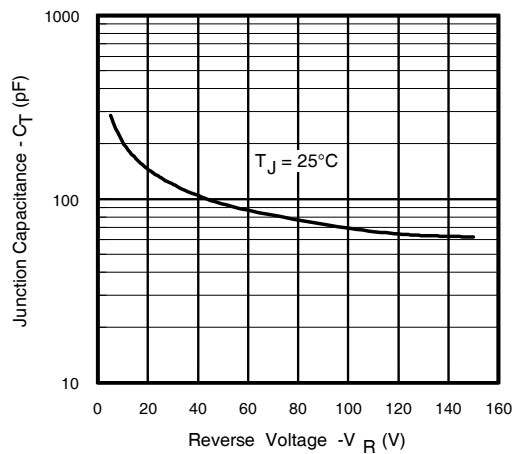
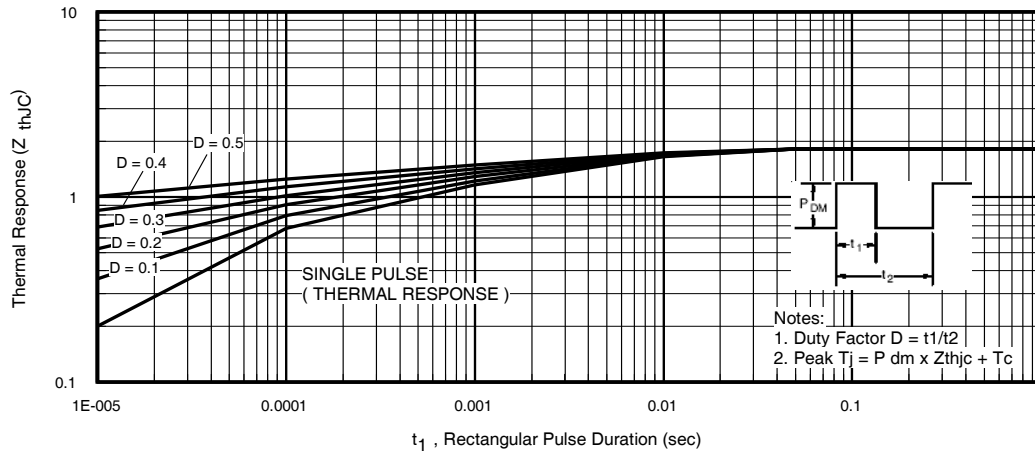
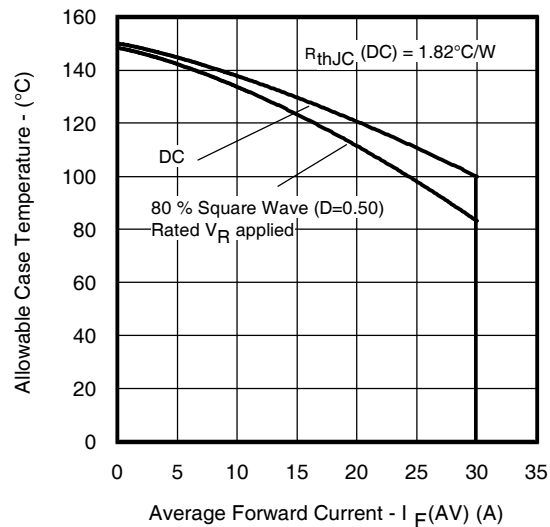


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage

Fig. 4 - Max. Thermal Impedance Z_{thJC} CharacteristicsFig. 5 - Max. Allowable Case Temperature Vs.
Average Forward CurrentInternational
IR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

IR LEOMINSTER : 205 Crawford St., Leominster, Massachusetts 01453, USA Tel: (978) 534-5776

TAC Fax: (310) 252-7903

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Data and specifications subject to change without notice. 07/2008

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